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ASSP For power supply applications

BIPOLAR

Power Supply Monitor

MB3771

■ DESCRIPTION

The Fujitsu Microelectronics MB3771 is designed to monitor the voltage level of one or two power supplies (+5 V and an arbitrary voltage) in a microprocessor circuit, memory board in large-size computer, for example. If the circuit's power supply deviates more than a specified amount, then the MB3771 generates a reset signal to the microprocessor. Thus, the computer data is protected from accidental erasure.

Using the MB3771 requires few external components. To monitor only a +5 V supply, the MB3771 requires the connection of one external capacitor. The level of an arbitrary detection voltage is determined by two external resistors. The MB3771 is available in an 8-pin Dual In-Line, Single In-Line Package or space saving Flat Package.

■ FEATURES

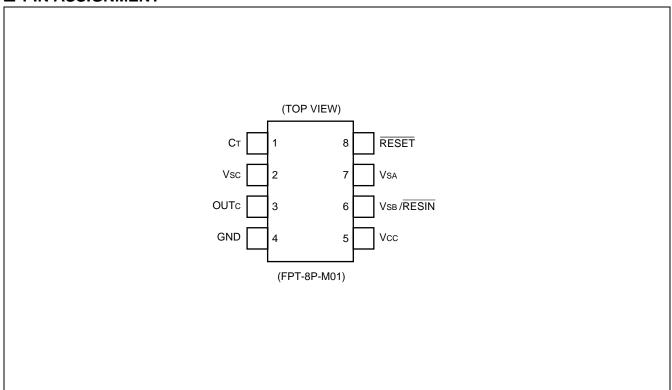
- Precision voltage detection ($V_{SA} = 4.2 \text{ V} \pm 2.5 \%$)
- User selectable threshold level with hysteresis (V_{SB} = 1.23 V \pm 1.5 %)
- Monitors the voltage of one or two power supplies (5 V and an arbitrary voltage, >1.23 V)
- Usable as over voltage detector
- Low voltage output for reset signal (Vcc = 0.8 V Typ)
- Minimal number of external components (one capacitor Min)
- Low power dissipation (Icc = 0.35 mA Typ, Vcc = 5 V)
- Detection threshold voltage has hysteresis function
- · Reference voltage is connectable.
- One type of package (SOP-8pin : 1 type)

APPLICATION

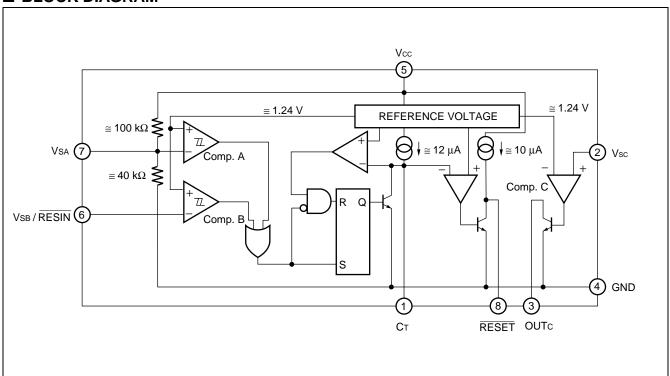
- · Industrial Equipment
- Arcade Amusement etc.



■ PIN ASSIGNMENT



■ BLOCK DIAGRAM



■ FUNCTIONAL DESCRIPTIONS

Comparators Comp.A and Comp.B apply a hysteresis to the detected voltage, so that when the voltage at either the V_{SA} or V_{SB} pin falls below 1.23 V the RESET output signal goes to "low" level.

Comp. B may be used to detect any given voltage(APPLICATION CIRCUIT 3: Arbitrary Voltage Supply Monitor), and can also be used as a forced reset pin (with reset hold time) with TTL input (APPLICATION CIRCUIT 6: 5V Power Supply Monitor with forced RESET input (Vcc = 5V)).

Note that if Comp.B is not used, the V_{SB} pin should be connected to the V_{CC} pin (APPLICATION CIRCUIT 1 : 5V Power Supply Monitor).

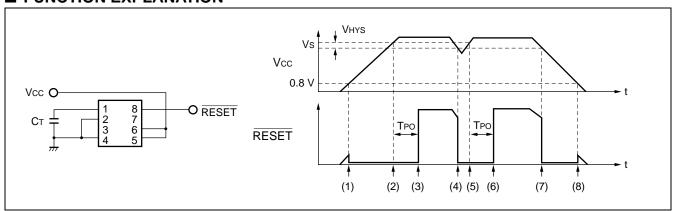
Instantaneous breaks or drops in the power supply can be detected as abnormal conditions by the MB3771 within a 2 μ s interval. However because momentary breaks or drops of this duration do not cause problems in actual systems in some cases, a delayed trigger function can be created by connecting capacitors to the V_{SA} or V_{SB} pin (APPLICATION CIRCUIT 8 : Supply Voltage Monitoring with Delayed Trigger).

Because the RESET output has built-in pull-up resistance, there is no need to connect to external pull-up resistance when connected to a high impedance load such as a CMOS logic IC.

Comparator Comp. C is an open-collector output comparator without hysteresis, in which the polarity of input/output characteristics is reversed. Thus Comp. C is useful for over-voltage detection (APPLICATION CIRCUIT 11: Low Voltage and Over Voltage Detection (Vcc = 5 V)) and positive logic RESET signal output (APPLICATION CIRCUIT 7: 5 V Power Supply Monitor with Non-inverted RESET), as well as for creating a reference voltage (APPLICATION CIRCUIT 10: Reference Voltage Generation and Voltage Sagging Detection).

Note that if Comp. C is not used, the Vsc pin should be connected to the GND pin (APPLICATION CIRCUIT 1: 5V Power Supply Monitor).

■ FUNCTION EXPLANATION



- (1) When Vcc rises to about 0.8V, RESET goes low.
- (2) When Vcc reaches Vs +VHYS, CT then begins charging. RESET remains low during this time
- (3) RESET goes high when CT begins charging.

- (4) When Vcc level drops lower then Vs, then RESET goes low and Ct starts discharging.
- (5) When Vcc level reaches Vs + VHYS, then CT starts charging.
 In the case of voltage sagging, if the period from the time Vcc goes lower than or equal to Vs to the time Vcc reaches Vs +VHYS again, is longer than tPI, (as specified in the AC Characteristics), CT is discharged and charged successively.
- (6) After TPO passes, and Vcc level exceeds Vs + VHYS, then RESET goes high.
- (7) Same as Point 4.
- (8) RESET remains low until Vcc drops below 0.8V.

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		
Parameter	Symbol	Min	Max	Unit
Power supply voltage	Vcc	-0.3	+20	V
	Vsa	-0.3	Vcc + 0.3 (< +20)	V
Input voltage	VsB	-0.3	+20	V
	Vsc	-0.3	+20	V
Power dissipation	PD	_	200 (Ta ≤ 85 °C)	mW
Storage temperature	Tstg	-55	+125	°C

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Va	Unit	
Farameter	Symbol	Min	Max	Offic
Power supply voltage	Vcc	3.5	18	V
Output current	IRESET	0	20	mA
Output current	Іоитс	0	6	mA
Operating ambient temperature	Та	-40	+85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

(Vcc = 5 V, Ta = + 25 °C)

Parameter	Symbol	Conditions	Value			Unit
raiailletei	Syllibol	Conditions	Min	Тур	Max	Oilit
Power supply current	Icc1	Vsb = 5 V, Vsc = 0 V	_	350	500	μΑ
Power supply current	Icc2	Vsb = 0 V, Vsc = 0 V	_	400	600	μΑ
	Vsal	Vcc	4.10	4.20	4.30	V
Detection valtage	(DOWN)	Ta = -40 °C to +85 °C	4.05	4.20	4.35	V
Detection voltage	Vsah (UP)	Vcc	4.20	4.30	4.40	V
	VSAH (UP)	Ta = -40 °C to +85 °C	4.15	4.30	4.45	V
Hysteresis width	VHYSA	_	50	100	150	mV
Detection valtage	VsB	V _{SB}	1.212	1.230	1.248	V
Detection voltage	V SB	Ta = -40 °C to +85 °C	1.200	1.230	1.260	V
Deviation of detection voltage	ΔV_SB	Vcc = 3.5 V to 18 V	_	3	10	mV
Hysteresis width	VHYSB	_	14	28	42	mV
Innut ourrent	Іінв	VSB = 5 V		0	250	nA
Input current	lilb	V _{SB} = 0 V	_	20	250	nA
	Vohr	$I_{RESET} = -5 \mu A$, $V_{SB} = 5 V$	4.5	4.9		V
Output voltage	Volr	IRESET = 3mA, Vsb = 0 V		0.28	0.4	V
		IRESET = 10mA, Vsb = 0 V		0.38	0.5	V
Output sink current	IRESET	Volr = 1.0 V, Vsb = 0 V	20	40		mA
CT charge current	Іст	Vsb = 5 V, Vct = 0.5 V	9	12	16	μΑ
Innest accurate	Інс	Vsc = 5 V		0	500	nA
Input current	lılc	Vsc = 0 V		50	500	nA
Detection valtage	\/	_	1.225	1.245	1.265	V
Detection voltage	Vsc	Ta = -40 °C to +85 °C	1.205	1.245	1.285	V
Deviation of detection voltage	ΔVsc	Vcc = 3.5 V to 18 V	_	3	10	mV
Output leakage current	Іонс	Vонс = 18 V	_	0	1	μΑ
Output voltage	Volc	louтc = 4 mA, Vsc = 5 V	_	0.15	0.4	V
Output sink current	Іоитс	Volc = 1.0 V, Vsc = 5 V	6	15	_	mA
Reset operation minimum supply voltage	Vccl	$V_{\text{OLR}} = 0.4 \text{ V}, \text{ Ireset} = 200 \mu\text{A}$		0.8	1.2	V

2. AC Characteristics

(Vcc = 5 V, Ta = +25 °C, C_T = 0.01 μ F)

Parameter	Symbol	Symbol Conditions		Value		
raiametei	Symbol Conditions -		Min	Тур	Max	Unit
Vsa, Vsb input pulse width	t PI	_	5.0	_	_	μs
Reset hold time	t PO	_	0.5	1.0	1.5	ms
RESET rise time	t r	$R_L = 2.2 \text{ k}\Omega$,	_	1.0	1.5	μs
RESET fall time	t _f	C∟ = 100 pF	_	0.1	0.5	μs
	t _{PD} *1	_	_	2	10	μs
Propagation delay time	tphl*2	$R_L = 2.2 \text{ k}\Omega$	_	0.5		μs
	t PLH*2	C _L = 100 pF		1.0	_	μs

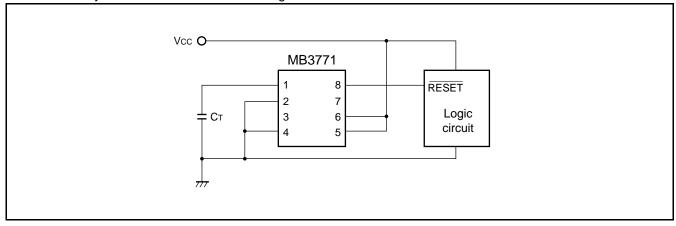
^{*1:} In case of V_{SB} termination.

^{*2:} In case of Vsc termination.

■ APPLICATION CIRCUIT

1. 5V Power Supply Monitor

Monitored by Vsa. Detection threshold voltage is Vsal and Vsah



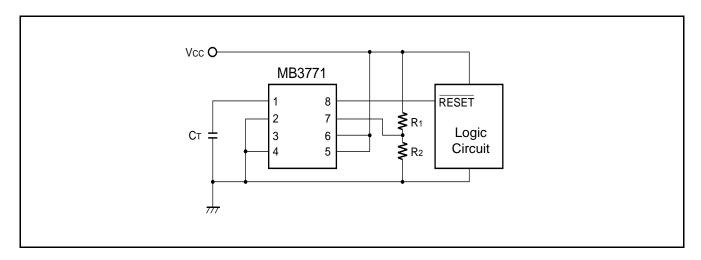
2. 5V Power Supply Voltage Monitor (Externally Fine-Tuned Type)

The VsA detection voltage can be adjusted externally.

Resistance R_1 and R_2 are set sufficiently lower than the IC internal partial voltage resistance, so that the detection voltage can be set using the ratio between resistance R_1 and R_2 . (Refer to the table below).

• R₁, R₂ calculation formula (when R₁ << 100 k Ω , R₂ <<40 k Ω) V_{SAL} \doteqdot (R₁ + R₂) × V_{SB}/R₂ [V], V_{SAH} \doteqdot (R₁ + R₂) × (V_{SB} + V_{HYSB})/ R₂ [V]

R ₁ (kΩ)	R ₂ (kΩ)	Detection voltage: VSAL (V)	Detection voltage: Vsah (V)
10	3.9	4.37	4.47
9.1	3.9	4.11	4.20

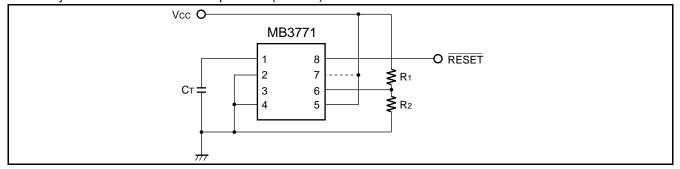


3. Arbitrary Voltage Supply Monitor

(1) Case: Vcc ≤ 18 V

- Detection Voltage can be set by R₁ and R₂.
 Detection Voltage = (R₁ + R₂) × V_{SB}/R₂
- Connect Pin 7 to Vcc when Vcc less than 4.45 V.
- Pin 7 can be opened when Vcc greater than 4.45 V
 Power Dissipation can be reduced.

Note: Hysteresis of 28 mV at V_{SB} at termination is available. Hysteresis width dose not depend on $(R_1 + R_2)$.

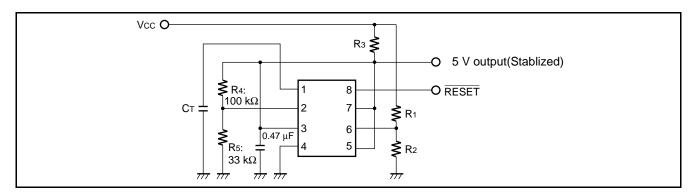


(2) Monitoring Vcc > 18 V

- Detection Voltage can be set by R₁ and R₂
 Detection Voltage = (R₁ + R₂) × V_{SB}/R₂
- The RESET signal output is \Rightarrow 0V (low level) and \Rightarrow 5 V (high level). Vcc voltage cannot be output. Do not pull up RESET to Vcc.
- Changing the resistance ratio between R₄ and R₅ changes the constant voltage output, thereby changing the voltage of the high level RESET output. Note that the constant voltage output should not exceed 18 V.
- The 5 V output can be used as a power supply for control circuits with low current consumption.
- In setting the R_3 resistance level, caution should be given to the power consumption in the resistor. The table below lists sample resistance values for reference (using 1/4 Ω resistance).

Vcc (V)	Detection voltage (V)	RESET Output min. power supply voltage (V)	R ₁ (MΩ)	R ₂ (kΩ)	R ₃ (k Ω)	Output Current (mA)
140	100	6.7	1.6	20	110	< 0.2
100	81	3.8	1.3	20	56	< 0.5
40	33	1.4	0.51	20	11	< 1.6

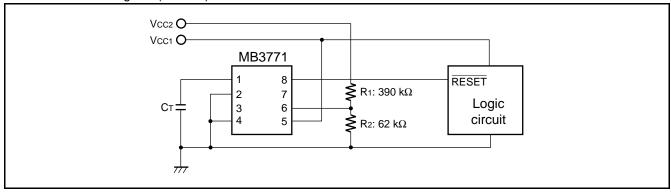
• Values are actual measured values (using $Ioutc = 100 \mu A$, Volc = 0.4 V). Lowering the resistance value of R₃ reduces the minimum supply voltage of the \overline{RESET} output, but requires resistance with higher allowable loss.



4. 5 V and 12 V Power Supply Monitor (2 types of power supply monitor Vcc1 = 5 V, Vcc2 = 12 V)

- 5 V is monitored by Vsa. Detection voltage is about 4.2 V
- 12 V is monitored by V_{SB}. When R₁ = 390 k Ω and R₂ = 62 k Ω , Detection voltage is about 9.0 V.Generally the detection voltage is determined by the following equation.

Detection Voltage = $(R_1 + R_2) \times V_{SB}/R_2$

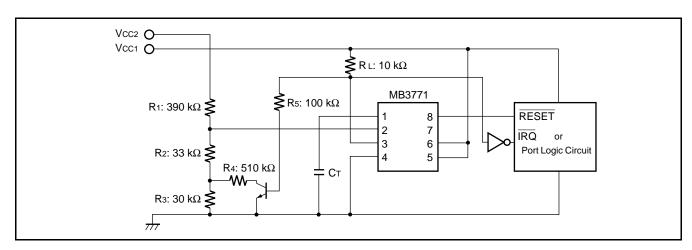


5. 5 V and 12 V Power Supply Monitor (RESET signal is generated by 5 V, Vcc1 = 5 V, Vcc2 = 12 V)

- 5 V is monitored by VsA, and generates RESET signal when VSA detects voltage sagging.
- 12 V is monitored by Vsc, and generates its detection signal at OUTc.
- The detection voltage of 12 V monitoring and its hysteresis is determined by the following equations.

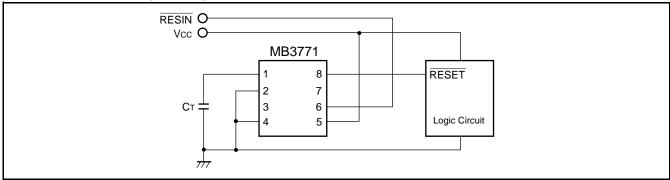
Detection voltage =
$$\frac{R_1 + R_2 + R_3}{R_2 + R_3} \times V_{SC}$$
 (8.95 V in the circuit above)

Hysteresis width =
$$\frac{R_1 (R_3 - R_3 /\!\!/ R_4)}{(R_2 + R_3) (R_2 + R_3 /\!\!/ R_4)} \times V_{SC}$$
 (200 mV in the circuit above)



6. 5 V Power Supply Monitor with forced \overline{RESET} input (Vcc = 5 V)

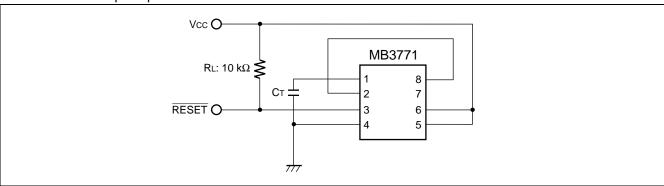
RESIN is an TTL compatible input.



7. 5 V Power Supply Monitor with Non-inverted RESET

In this case, Comparator C is used to invert RESET signal. OUTC is an open-collector output.

RL is used an a pull-up resistor.

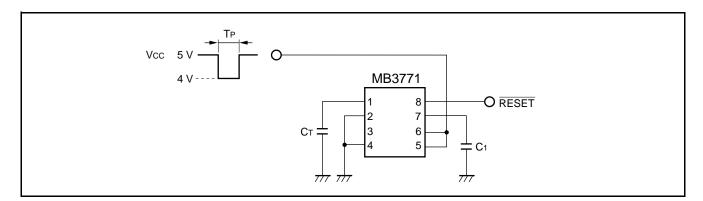


8. Supply Voltage Monitoring with Delayed Trigger

When the voltage shown in the diagram below is applied at Vcc, the minimum value of the input pulse width is increased to 40 μs (when $C_1 = 1000 \text{ pF}$).

The formula for calculating the minimum value of the input pulse width $[T_{\text{Pl}}]$ is:

T_{PI} [μ s] \Rightarrow 4 \times 10⁻² \times C₁ [pF]



9. Dual (Positive/Negative) Power Supply Voltage Monitoring (Vcc = 5 V, VEE = Negative Power Supply)

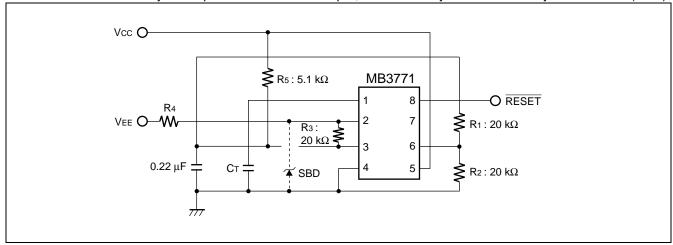
Monitors a 5 V and a negative (any given level) power supply. R₁, R₂, and R₃ should be the same value.

Detection Voltage = $V_{SB} - V_{SB} \times R_4/R_3$

Example if $V_{EE} = -5 \text{ V}$, $R_4 = 91 \text{ k}\Omega$

Then the detected voltage = -4.37 V

In cases where VEE may be output when VCC is not output, it is necessary to use a Schottky barrier diode (SBD).

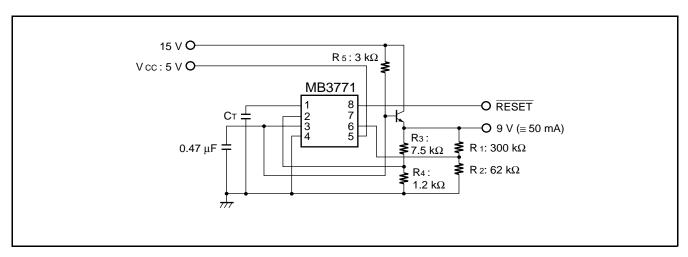


10. Reference Voltage Generation and Voltage Sagging Detection

(1) 9V Reference Voltage Generation and 5V/9V Monitoring

Detection Voltage = 7.2 V

In the above examples, the output voltage and the detection voltage are determined by the following equations: Detection Voltage = $(R_1 + R_2) \times V_{SB}/R_2$

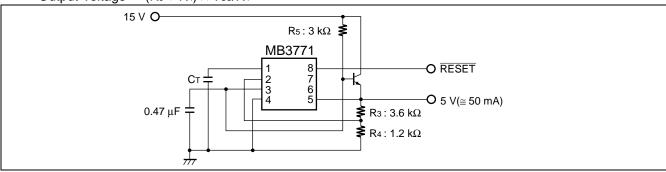


(2) 5 V Reference Voltage Generation and 5V Monitoring (No.1)

Detection Voltage = 4.2 V

In the above examples, the output voltage and the detection voltage are determined by the following equations:

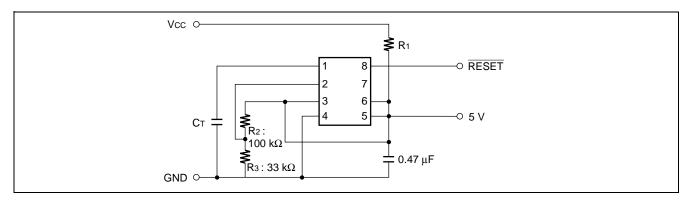
Output Voltage = $(R_3 + R_4) \times Vsc/R_4$



(3) 5 V Reference Voltage Generation and 5 V Monitoring (No. 2)

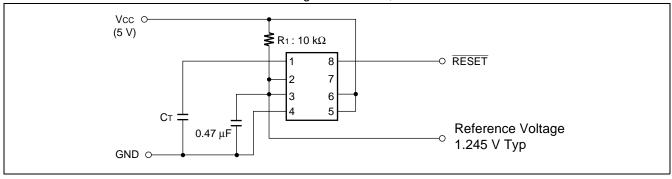
The value of R_1 should be calculated from the current consumption of the MB3771, the current flowing at R_2 and R_3 , and the 5 V output current. The table below provides sample resistance values for reference.

Vcc (V)	R ₁ (k Ω)	Output Current (mA)
40	11	< 1.6
24	6.2	< 1.4
15	4.7	< 0.6



(4) 1.245 V Reference Voltage Generation and 5 V Monitoring

Resistor R₁ determines Reference current. Using 1.2 k Ω as R₁, reference current is about 2 mA.

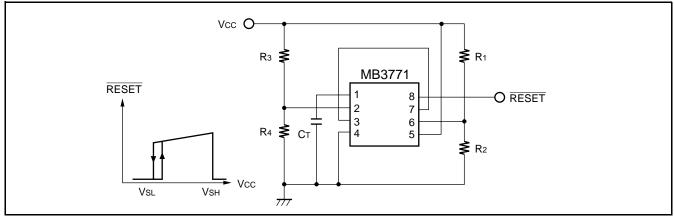


11. Low Voltage and Over Voltage Detection (Vcc = 5 V)

V_{SH} has no hysteresis. When over voltage is detected, RESET is held in the constant time as well as when low voltage is detected.

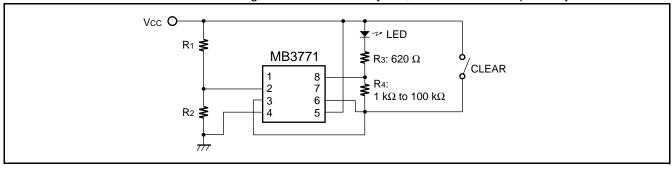
$$V_{SL} = (R_1 + R_2) \times V_{SB}/R_2$$

$$V_{SH} = (R_3 + R_4) \times V_{SC}/R_4$$



12. Detection of Abnormal State of Power Supply System (Vcc = 5 V)

- This Example circuit detects abnormal low/over voltage of power supply voltage and is indicated by LED indicator. LED is reset by the CLEAR key.
- The detection levels of low/over voltages are determined by VsA, and R1 and R2 respectively.



13. Back-up Power Supply System (Vcc = 5 V)

- Use CMOS Logic and connect VDD of CMOS logic with Vcco.
- The back-up battery works after CS goes high as $V_2 < V_1$.
- During tpo, memory access is prohibited.
- CS's threshold voltage V₁ is determined by the following equation:

$$V_1 = V_F + (R_1 + R_2 + R_3) \times V_{SB}/R_3$$

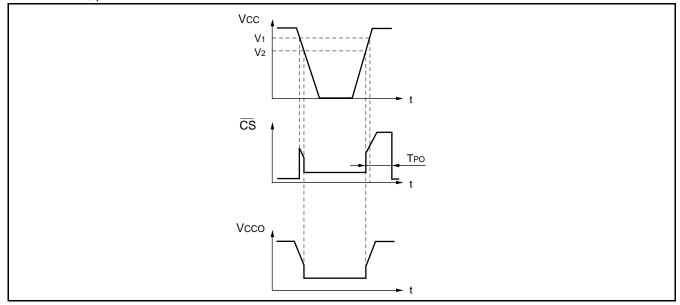
When V_1 is 4.45 V or less, connect 7 pin with V_{CC} .

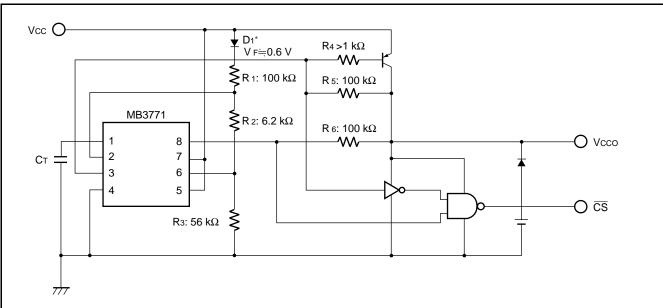
When V₁ is 4.45 V or more, 7 pin can be used to open.

• The voltage to change V₂ is provided as the following equation:

$$V_2 = V_F + (R_1 + R_2 + R_3) \times V_{SC}/(R_2 + R_3)$$

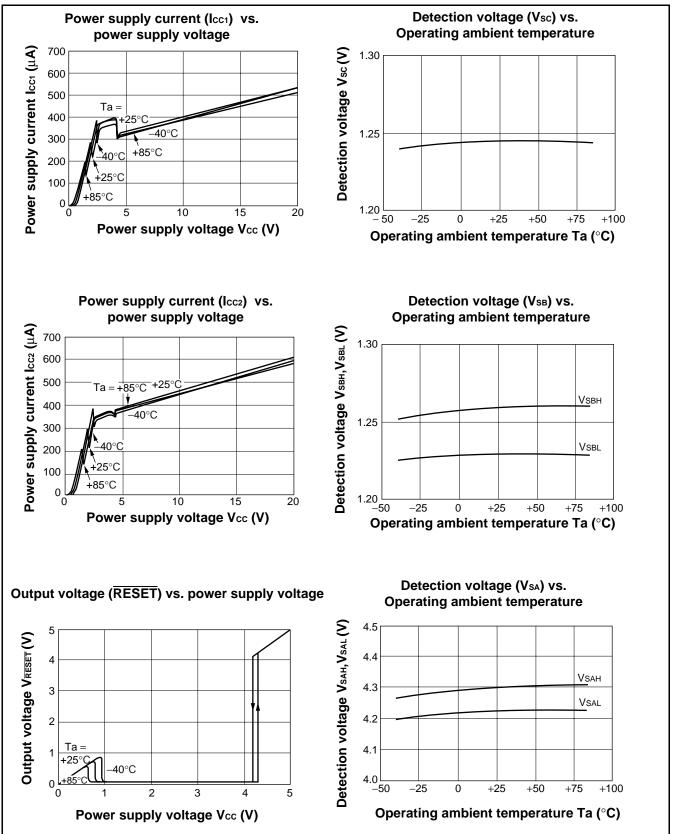
However, please set V2 to 3.5 V or more.





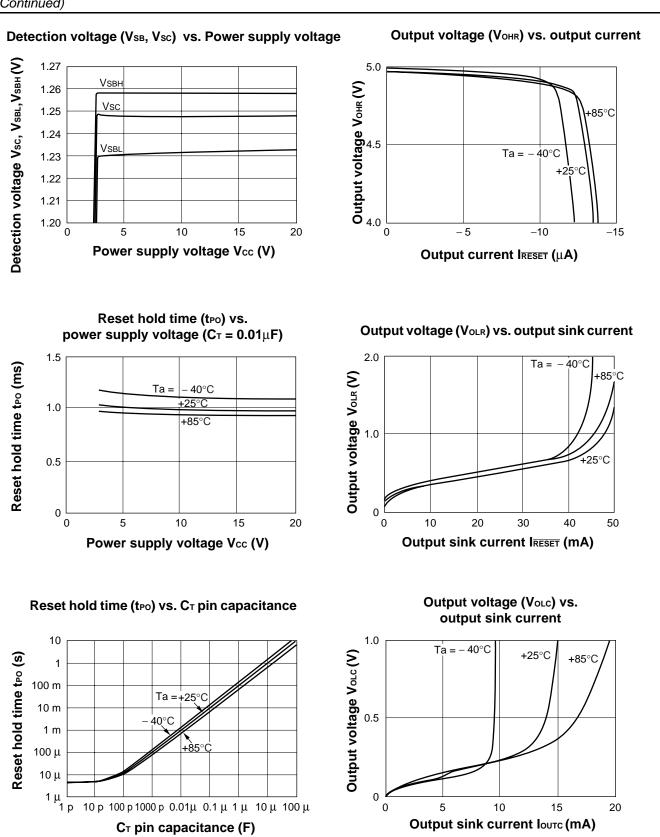
*: Diode has been added to prevent Comp.C from malfunctioning when Vcc voltage is low. Set V1 and V2 with care given to VF temperature characteristics (typically negative temperature characteristics).

■ TYPICAL CHARACTERISTICS



(Continued)

(Continued)



■ NOTES ON USE

- Take account of common impedance when designing the earth line on a printed wiring board.
- Take measures against static electricity.
 - For semiconductors, use antistatic or conductive containers.
 - When storing or carrying a printed circuit board after chip mounting, put it in a conductive bag or container.
 - The work table, tools and measuring instruments must be grounded.
 - The worker must put on a grounding device containing 250 k Ω to 1 M Ω resistors in series.
- Do not apply a negative voltage
 - Applying a negative voltage of -0.3 V or less to an LSI may generate a parasitic transistor, resulting in malfunction.

■ ORDERING INFORMATION

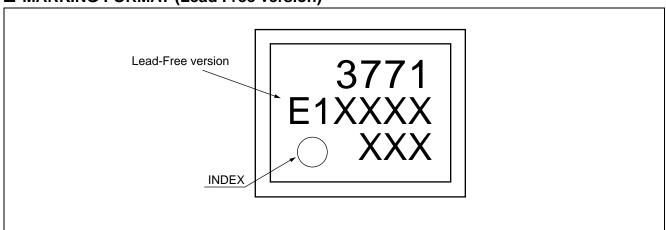
Part number	Package	Remarks
MB3771PF-□□□	8-pin Plastic SOP (FPT-8P-M01)	Conventional version
MB3771PF-□□□E1	8-pin Plastic SOP (FPT-8P-M01)	Lead Free version

■ RoHS Compliance Information of Lead (Pb) Free version

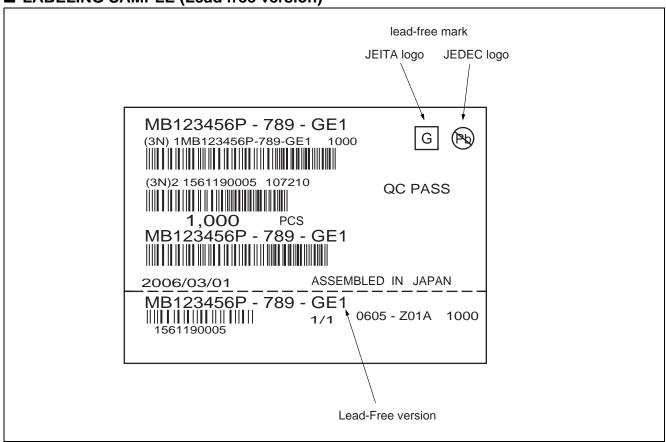
The LSI products of Fujitsu Microelectronics with "E1" are compliant with RoHS Directive, and has observed the standard of lead, cadmium, mercury, Hexavalent chromium, polybrominated biphenyls (PBB), and polybrominated diphenyl ethers (PBDE).

The product that conforms to this standard is added "E1" at the end of the part number.

■ MARKING FORMAT (Lead Free version)



■ LABELING SAMPLE (Lead free version)

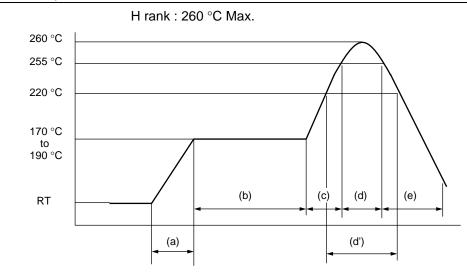


■ MB3771PF-□□□E1 Recommended Conditions of Moisture Sensitivity Level

Item	Condition					
Mounting Method	IR (infrared reflow), Manual so	IR (infrared reflow), Manual soldering (partial heating method)				
Mounting times	2 ti	mes				
	Before opening	Please use it within two years after Manufacture.				
Storage period	From opening to the 2nd reflow	Less than 8 days				
	When the storage period after opening was exceeded	Please processes within 8 days after baking (125 °C, 24H)				
Storage conditions	5 °C to 30 °C, 70%RH or less (the lowest possible humidity)					

[Temperature Profile for FJ Standard IR Reflow]

(1) IR (infrared reflow)



(a) Temperature Increase gradient : Average 1 °C/s to 4 °C/s

(b) Preliminary heating : Temperature 170 °C to 190 °C, 60s to 180s

(c) Temperature Increase gradient : Average 1 °C/s to 4 °C/s

(d) Actual heating : Temperature 260 °C MAX; 255 °C or more, 10s or less

(d') Main heating : Temperature 230 °C or more, 40s or less

or

Temperature 225 °C or more, 60s or less

or

Temperature 220 $^{\circ}\text{C}$ or more, 80s or less

(e) Cooling : Natural cooling or forced cooling

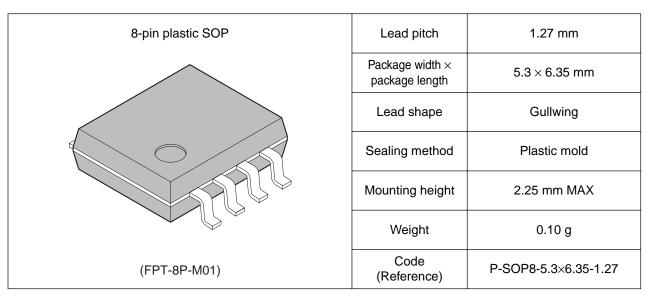
Note: Temperature: the top of the package body

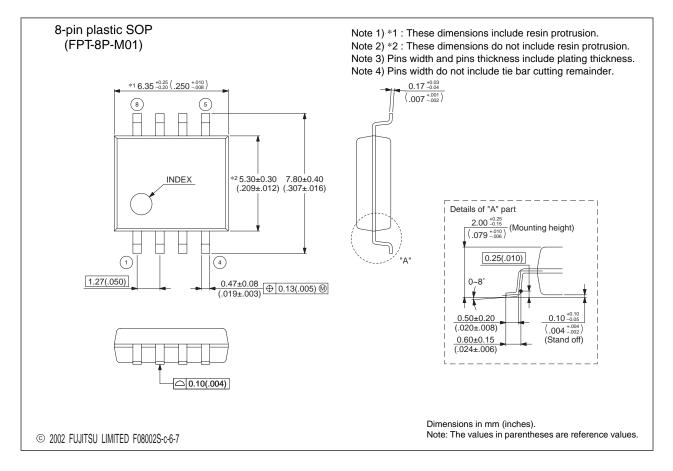
(2) Manual soldering (partial heating method)

Conditions : Temperature 400 °C MAX

Times : 5 s max/pin

■ PACKAGE DIMENSIONS





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FUJITSU MICROELECTRONICS LIMITED

Shinjuku Dai-Ichi Seimei Bldg. 7-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo 163-0722, Japan Tel: +81-3-5322-3347 Fax: +81-3-5322-3387 http://jp.fujitsu.com/fml/en/

For further information please contact:

North and South America

FUJITSU MICROELECTRONICS AMERICA, INC. 1250 E. Arques Avenue, M/S 333
Sunnyvale, CA 94085-5401, U.S.A.
Tel: +1-408-737-5600 Fax: +1-408-737-5999
http://www.fma.fujitsu.com/

Europe

FUJITSU MICROELECTRONICS EUROPE GmbH Pittlerstrasse 47, 63225 Langen, Germany Tel: +49-6103-690-0 Fax: +49-6103-690-122

Tel: +49-6103-690-0 Fax: +49-6103-690-122 http://emea.fujitsu.com/microelectronics/

Korea

FUJITSU MICROELECTRONICS KOREA LTD. 206 KOSMO TOWER, 1002 Daechi-Dong, Kangnam-Gu,Seoul 135-280 Korea

Tel: +82-2-3484-7100 Fax: +82-2-3484-7111

http://www.fmk.fujitsu.com/

Asia Pacific

FUJITSU MICROELECTRONICS ASIA PTE LTD.

151 Lorong Chuan, #05-08 New Tech Park,
Singapore 556741

Tel: +65-6281-0770 Fax: +65-6281-0220

http://www.fujitsu.com/sg/services/micro/semiconductor/

FUJITSU MICROELECTRONICS SHANGHAI CO., LTD. Rm.3102, Bund Center, No.222 Yan An Road(E), Shanghai 200002, China Tel: +86-21-6335-1560 Fax: +86-21-6335-1605 http://cn.fujitsu.com/fmc/

FUJITSU MICROELECTRONICS PACIFIC ASIA LTD.

10/F., World Commerce Centre, 11 Canton Road
Tsimshatsui, Kowloon
Hong Kong
Tel: +852-2377-0226 Fax: +852-2376-3269
http://cn.fujitsu.com/fmc/tw

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Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com